

CLAIMS

1. A method of manufacturing a circuit forming board, comprising:
transferring a first sheet having a first direction in a second
direction, so that the first direction of the first sheet is parallel to the second
5 direction; and

sticking films onto both surfaces of the first sheet while
transferring the first sheet in a third direction orthogonal to the first
direction of the first direction of the first sheet.

10 2. The method as defined in claim 1, wherein said sticking the films
comprises pressing the films on the first sheet with a heated roller while
transferring the first sheet in the third direction.

3. The method as defined in claim 1, wherein said transferring the
15 first sheet in the second direction comprises impregnating a reinforcing
member with impregnation material while transferring the reinforcing
member in the second direction so as to provide the first sheet, the
reinforcing member having a direction corresponding to the first direction of
the first sheet, the direction of the reinforcing member being parallel to the
20 second direction.

4. The method as defined in claim 3, wherein the reinforcing member
comprises woven fabric.

25 5. The method as defined in claim 1, further comprising:
forming a via-hole in the first sheet having the films stacked
thereon;

filling the via-hole with conductive paste;
peeling off the films from the first sheet; and
heating and pressing metallic foils onto both surfaces of the first
sheet after said peeling off the films.

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6. The method as defined in claim 1, wherein the first sheet has a rectangular shape having a long-side direction and a short-side direction, and the long-side direction is orthogonal to the first direction of the first sheet.

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7. The method as defined in claim 1, further comprising cutting a second sheet while transferring the second sheet in the second direction as to providing the first sheet.

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8. A material of a circuit forming board, the material comprising a sheet having a substantially-rectangular shape having a short-side direction, the sheet being formed by cutting a material member while transferring the material member in a first direction parallel with the short-side direction.

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9. A material of a circuit forming board, the material comprising a sheet having a substantially-rectangular shape having a short-side direction, the sheet being formed by impregnating the reinforcing member with impregnation material and cutting the reinforcing member while transferring a reinforcing member in a first direction parallel with the
25 short-side direction.